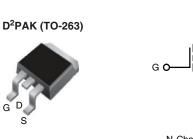
Vishay Siliconix



E Series Power MOSFET



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N-Channel MOSFET

PRODUCT SUMMARY						
V _{DS} (V) at T _J max.	650					
R _{DS(on)} max. (Ω) at 25 °C	$V_{GS} = 10 V$	0.099				
Q _g max. (nC)	150					
Q _{gs} (nC)	24					
Q _{gd} (nC)	42					
Configuration	Single					

FEATURES

- Low figure-of-merit (FOM): Ron x Qg
- Low input capacitance (C_{iss})
- · Reduced switching and conduction losses
- Ultra low gate charge (Q_a)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Renewable energy
 - Solar (PV inverters)

ORDERING INFORMATION				
Package	D ² PAK (TO-263)			
Lead (Pb)-free	SiHB33N60E-E3			
	SiHB33N60E-GE3			
Lead (Pb)-free and Halogen-free	SiHB33N60ET5-GE3			
	SiHB33N60ET1-GE3			

PARAMETER	SYMBOL	LIMIT	UNIT		
Drain-Source Voltage	V _{DS}	600	v		
Gate-Source Voltage	V _{GS}	± 30	v		
Continuous Drain Current (T. 150 °C)	V at 10 V	$T_C = 25 \degree C$ $T_C = 100 \degree C$		33	
Continuous Drain Current (T _J = 150 °C)	V _{GS} at 10 V	$T_C = 100 \ ^\circ C$	I _D	21	A
Pulsed Drain Current ^a	I _{DM}	88			
Linear Derating Factor		2.2	W/°C		
Single Pulse Avalanche Energy ^b			E _{AS}	793	mJ
Maximum Power Dissipation	PD	278	W		
Operating Junction and Storage Temperature Range	T _J , T _{stg}	-55 to +150	°C		
Drain-Source Voltage Slope	$V_{DS} = 0 V t$	o 80 % V _{DS}	d\//dt	70	1//20
Reverse Diode dV/dt d		dV/dt	12	V/ns	
Soldering Recommendations (Peak temperature) ^c	10 s		300	°C	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature

b. $V_{DD} = 50$ V, starting T_J = 25 °C, L = 28.2 mH, R_g = 25 Ω , I_{AS} = 7.5 A

c. 1.6 mm from case

d. $I_{SD} \leq I_D$, dI/dt = 100 A/µs, starting T_J = 25 °C

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THERMAL RESISTANCE RATINGS							
PARAMETER	SYMBOL	TYP.	MAX.	UNIT			
Maximum Junction-to-Ambient	R _{thJA}	-	62	°C/W			
Maximum Junction-to-Case (Drain)	R _{thJC} - 0.45		0/11				

PARAMETER	SYMBOL	TES	MIN.	TYP.	MAX.	UNIT	
Static					•		
Drain-Source Breakdown Voltage	V _{DS}	V _{GS}	600	-	-	V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_J$	Reference to 25 °C, I _D = 1 mA		-	0.71	-	V/°C
Gate-Source Threshold Voltage (N)	V _{GS(th)}	V _{DS} :	2.0	-	4.0	V	
Gate-Source Leakage	I _{GSS}		$V_{GS} = \pm 20 V$		-	± 100	nA
Gale-Source Leakage			$V_{GS} = \pm 30 \text{ V}$	-	-	± 1	μA
Zave Cate Veltage Drain Current		V _{DS} =	= 600 V, V _{GS} = 0 V	-	-	1	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 480 V	$V_{DS} = 480 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 125 \text{ °C}$		-	10	μA
Drain-Source On-State Resistance	R _{DS(on)}	$V_{GS} = 10 V$	I _D = 16.5 A	-	0.083	0.099	Ω
Forward Transconductance ^a	9 _{fs}	V _{DS} :	= 30 V, I _D = 16.5 A	-	11	-	S
Dynamic							
Input Capacitance	C _{iss}		$V_{GS} = 0 V,$	-	3508	-	-
Output Capacitance	C _{oss}		V _{DS} = 100 V,	-	156	-	
Reverse Transfer Capacitance	C _{rss}		f = 1 MHz	-	6	-	
Effective Output Capacitance, Energy Related ^b	C _{o(er)}					-	pF
Effective Output Capacitance, Time Related ^c	C _{o(tr)}	- V _{GS} = 0	$V_{GS} = 0 V, V_{DS} = 0 V to 480 V$		468	-	1
Total Gate Charge	Qq			-	100	150	
Gate-Source Charge	Q _{gs}	V _{GS} = 10 V	I _D = 16.5 A, V _{DS} = 480 V	-	24	-	nC
Gate-Drain Charge	Q _{gd}			-	42	-	
Turn-On Delay Time	t _{d(on)}			-	28	56	
Rise Time	t _r	V _{DD} =	480 V, I _D = 16.5 A	-	60	90	
Turn-Off Delay Time	t _{d(off)}		9.1 Ω, V _{GS} = 10 V	-	99	150	ns
Fall Time	t _f			-	54	80	
Gate Input Resistance	Rg	f = 1	f = 1 MHz, open drain		0.7	1.0	Ω
Drain-Source Body Diode Characteristic	s			•	•	•	•
Continuous Source-Drain Diode Current	I _S	MOSFET sym showing the	bol	-	-	33	
Pulsed Diode Forward Current	I _{SM}	integral revers p - n junction		-	-	88	A
Diode Forward Voltage	V _{SD}	T _J = 25 °C	C, I _S = 16.5 A, V _{GS} = 0 V	-	0.9	1.2	V
Reverse Recovery Time	t _{rr}			-	503	1006	ns
Reverse Recovery Charge	Q _{rr}		= 25 °C, $I_F = I_S$, 100 A/us V = 20 V	-	8.5	17	μC
Reverse Recovery Current	I _{RRM}	$dI/dt = 100 \text{ A}/\mu \text{s}, \text{ V}_{\text{R}} = 20 \text{ V}$		-	26	-	Α

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature

b. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}

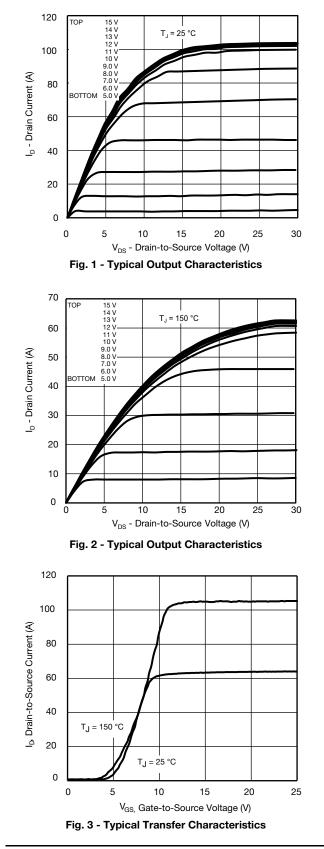
c. $C_{oss(tr)}$ is a fixed capacitance that gives the charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



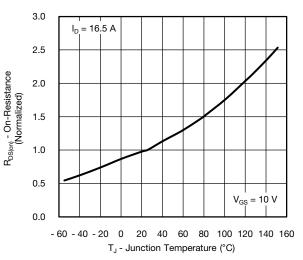


Fig. 4 - Normalized On-Resistance vs. Temperature

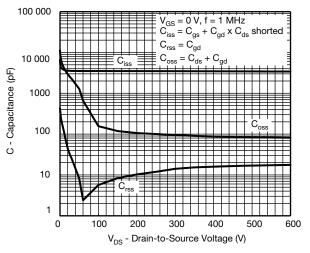
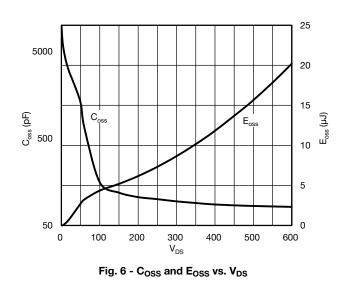


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage



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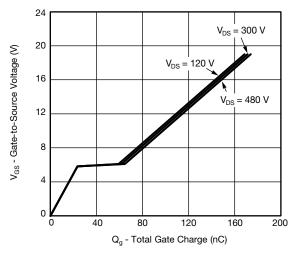


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

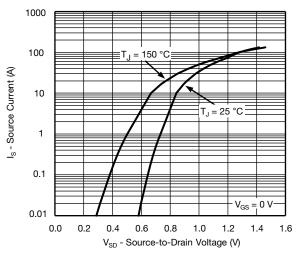
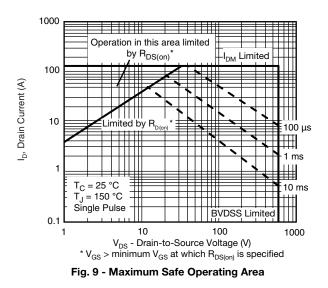


Fig. 8 - Typical Source-Drain Diode Forward Voltage



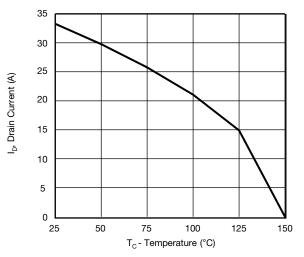


Fig. 10 - Maximum Drain Current vs. Case Temperature

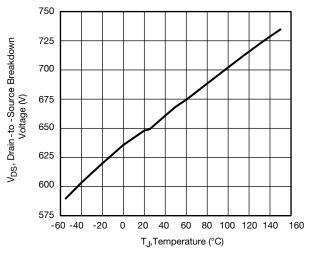


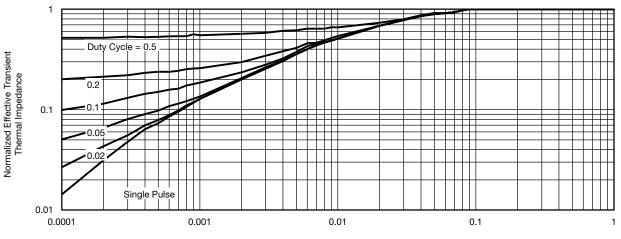
Fig. 11 - Typical Drain-to-Source Voltage vs. Temperature

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Square Wave Pulse Duration (s)



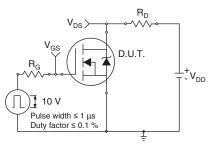


Fig. 13 - Switching Time Test Circuit

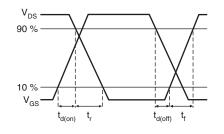


Fig. 14 - Switching Time Waveforms

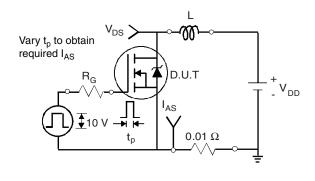


Fig. 15 - Unclamped Inductive Test Circuit

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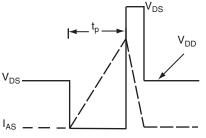


Fig. 16 - Unclamped Inductive Waveforms

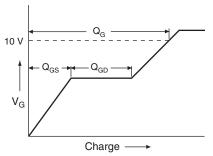
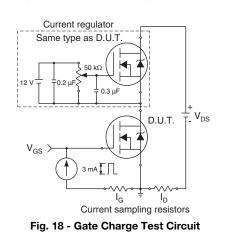


Fig. 17 - Basic Gate Charge Waveform



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Peak Diode Recovery dV/dt Test Circuit

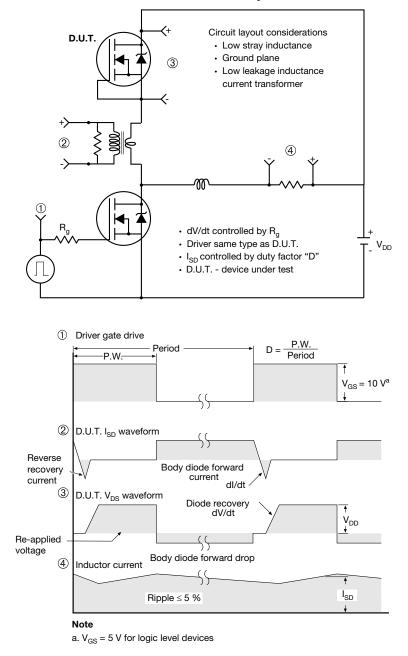


Fig. 19 - For N-Channel

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H

A1

B

Gauge plane

L3

Detail "A" Rotated 90° CW scale 8:1

0° to 8° **Vishay Siliconix**

Seating plane

TO-263AB (HIGH VOLTAGE)

/3 ⁄4 A

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Detail A

(Datum A)

D

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	2	-	Y 2 x b2 2 x b ⊕ 0.010 @ A(■ ating 5 b1, b b1, b b1, b c) c) c) c) c) c) c) c) c) c)	$\begin{array}{c} c_{1} \\ c_{1} \\ c_{2} \\ c_{3} \\ c_{4} \\ c_{5} \\ c_{5} \\ c_{7} \\$	a - 1		Ū.	1 <u>4</u>	
	MILLIN	IETERS	INC	INCHES			MILLIN	IETERS	INCHES	
DIM.	MIN.	MAX.	MIN.	MAX.		DIM.	MIN.	MAX.	MIN.	MAX.
А	4.06	4.83	0.160	0.190		D1	6.86	-	0.270	-
				0.010		F		10.07	0.000	0.420
A1	0.00	0.25	0.000	0.010		E	9.65	10.67	0.380	0.120
A1 b	0.00 0.51	0.25 0.99	0.000	0.010		E1	9.65 6.22	- 10.67	0.380	-
							6.22	- 10.67 - BSC	0.245	- BSC
b	0.51	0.99	0.020	0.039		E1	6.22	-	0.245	-
b b1	0.51 0.51	0.99 0.89	0.020 0.020	0.039 0.035		E1 e	6.22 2.54	- BSC	0.245	-) BSC
b b1 b2	0.51 0.51 1.14	0.99 0.89 1.78	0.020 0.020 0.045	0.039 0.035 0.070		E1 e H	6.22 2.54 14.61	- BSC 15.88	0.245 0.100 0.575	-) BSC 0.625
b b1 b2 b3	0.51 0.51 1.14 1.14	0.99 0.89 1.78 1.73	0.020 0.020 0.045 0.045	0.039 0.035 0.070 0.068		E1 e H L	6.22 2.54 14.61 1.78	- BSC 15.88 2.79	0.245 0.100 0.575 0.070	- 0 BSC 0.625 0.110
b b1 b2 b3 c	0.51 0.51 1.14 1.14 0.38	0.99 0.89 1.78 1.73 0.74	0.020 0.020 0.045 0.045 0.015	0.039 0.035 0.070 0.068 0.029		E1 e H L L1	6.22 2.54 14.61 1.78 - -	- BSC 15.88 2.79 1.65	0.245 0.100 0.575 0.070 - -	- 0 BSC 0.625 0.110 0.066
b b1 b2 b3 c c1	0.51 0.51 1.14 1.14 0.38 0.38	0.99 0.89 1.78 1.73 0.74 0.58	0.020 0.020 0.045 0.045 0.015 0.015	0.039 0.035 0.070 0.068 0.029 0.023		E1 e H L L1 L2	6.22 2.54 14.61 1.78 - -	- BSC 15.88 2.79 1.65 1.78	0.245 0.100 0.575 0.070 - -	- 0 BSC 0.625 0.110 0.066 0.070

Α

Notes

1. Dimensioning and tolerancing per ASME Y14.5M-1994.

2. Dimensions are shown in millimeters (inches).

3. Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body at datum A.

4. Thermal PAD contour optional within dimension E, L1, D1 and E1.

5. Dimension b1 and c1 apply to base metal only.

6. Datum A and B to be determined at datum plane H.

7. Outline conforms to JEDEC outline to TO-263AB.



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RECOMMENDED MINIMUM PADS FOR D²PAK: 3-Lead



Recommended Minimum Pads Dimensions in Inches/(mm)

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